

RZ/V2H Group

Handbook for RZ/V2H

Introduction

This document compiles useful information for each stage of device selection, development, and Mass production. You can also select what you need for your application from our rich selection of application notes that describe how to use a peripheral function, example applications, how to create a program, and more.

Please utilize these information, materials and application notes as a handbook when developing.

Target Device

RZ/V2H Group

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1. The Table of Information and Materials Needed for Device Selection, Development and Mass Production

1.1 Step1: Device Selection

This section summarizes the information that is useful for the preliminary survey phase (Step1-1) and for the evaluation phase for device performance and features (Step1-2) when selecting the device.

1.1.1 Step1-1: Preliminary survey phase

#	Item	Contents	Link
1	Hardware information	Datasheet	Doc
2		RZ/V2H Group Flyer	Doc
3		RZ Family Brochure	Doc
4		Video	Web site
5		Blog	Web site
6	Product & Solutions	Reference designs (Winning Combination)	
		- Robot Vacuum Cleaner	Web site
		- High-Performance Vision AI System	Web site
		- Single Board Computer with Vision AI	Web site
		- Power Sequencer & I/O Expander for Printers (PPC/MFP)	Web site
		- Autonomous Mobile Robot (AMR)	Web site
		- Unmanned Aerial Vehicle (UAV)	Web site
		- Service Robot	Web site
		- Robotic Standard Arm System	Web site
		- Dexterous Hand	Web site
7	Product Specification	RZ Family Product Selector	Web site
8	Comparison	White Paper	Web site
9	Partner information	Preferred Partner Program (System solutions provider)	Web site
10		RZ Family Partner Ecosystem	Web site

1.1.2 Step1-2: Evaluation phase for device performance and features

#	Item	Contents	Link
User's Manual / Documentation			
1	Document	RZ/V2H Group User's manual: Hardware	Doc
2		RZ/V2H Group User's manual: Hardware (Additional Document)	Doc *2
3		Technical update (errata information)	Web site
4		Product change notice (PCN)	Web site
5		RZ Family Product Part Number Guide (the meaning of character in part number)	Doc
6		Semiconductor reliability handbook	Doc
7		Reliability Report	Doc
Evaluation Board			
8	Evaluation Board (for General purpose)	RZ/V2H-EVK Vision AI MPU Evaluation Kit	Web site
Evaluation environment (set up method)			
9	Hardware (Set up EVK)	RZ/V2H-EVK Hardware Manual	Doc
10		Camera module list for RZ/V series	Doc
11		Camera module for EVK (*) External link - e-CAM22_CURZH information	Web site
12		Camera module for EVK (*) External link - V2H IMX415 Board information - V2H IMX415 Board-M12 information	Web site Web site
13	AI SDK	RZ/V AI Web page - Software Overview - Getting Started - How to build RZ/V2H AI SDK Source Code - AI Applications Demo How to Use Guide - Community (Community Applications) - RZ/V Reference Applications	Web site Web site Web site Web site Web site Web site Web site
14		RZ/V2H AI SDK Overview	Web site
15		RZ/V2H AI SDK Release Note	Doc
16		RZ/V2H AI SDK	File *1
17	Linux (Manual set)	RZ/V2H AI SDK Source Code	File *1
18		BSP (RTK0EF0045Z94001AZJ-v1.0.3.zip)	File
19		Linux Interface Specification GStreamer User Manual: Software	Doc *1
20	Linux (Security Package)	Security Solution Overview	Doc
21		Security Package	File *2
22	Multi-OS	RZ/V Multi-OS Package Overview	Web site
23		RZ/V Multi-OS Package Release Note	Doc
24		RZ/V Multi-OS Package Compressed file	File
25		AWO (Always On) Startup Guide	Doc
26		FSP (Flexible Software Package)	File
27	ISP Support Package	FSP Getting Started Guide	Doc
28		ISP Support Package Overview	Web site
29		ISP Support Package Guide	Doc
30		Release Note	Doc *2
31		Image Quality Tuning Guide	Doc *2
32	ROS2 Support Package	ISP Support Package (supported IMX415)	File *2
33		ROS2 Package Overview	Web site
34		ROS2 Support Package	Web site
35		ROS2 Sample Application Package	Web site

Evaluation environment (set up method)			
36	Various tools	DRP-AI TVM (GitHub)	Web site
37		DRP-AI TVM Guideline (GitHub Pages)	Web site
38		DRP-AI Translator i8 Installer	File ^{*1}
39		DRP-AI Translator i8 Release Note	Doc
40		DRP-AI Extension Pack (Pruning tool) Manual	Doc
41		DRP-AI Extension Pack (Pruning tool)	File ^{*1}
42		DRP-AI Pruning Guideline (GitHub)	Web site
43		AI Navigator: IDE for AI Applications	Web site
44		<i>AI Navigator Quick Start Guide</i> (GitHub)	Web site
45		e ² studio Installer for Windows	File ^{*1}
46		e ² studio Installer for Linux	File ^{*1}
47		Smart Configurator for RZ	File ^{*1}
48		Smart Configurator for RZ Release Note	Doc

*1: To access contents of software packages, My Renesas account is required.

*2: NDA required for access to secure site.

1.2 Step2: Product Design, Development

This section summarizes useful information for product design and development.
(Note: To access contents of board design data, My Renesas account is required.)

#	Item	Contents	Link
1	Board Design	LPDDR4/4X Controller Setting guide - Setting parameters generation tool (Gen_tool)	Doc ^{*1}
2		PCB Design Checklist	Doc ^{*2}
3		PCB Design guide	Doc ^{*1}
4		Thermal design Guide	Doc
5		LSI Design Model (IBIS) - 1 chip IBIS model	Model ^{*1}
6		Interface Design Model (Spara, IBIS) - SI simulation models for high-speed interfaces - PI simulation models	Model ^{*1*2}
7		CPU Board Design Data	Data
8		EXP Board Design Data	Data
9		Recommended DRAM list	Doc
10		Recommended PMIC - RAA215300 (RAA215300A2GNP#HA2/#HA7) ^{*3}	Web site
11		Packaging Information	Web site
12		Package Search (pkg_20143/FBGA 840)	Web site
13		BSDL (Boundary Scan Description Language)	Data ^{*1}

*1: NDA required for access to secure site.

*2: Please refer to this checklist during PCB design. It is also recommended to utilize these models for SI/PI simulations. Even when reference board design data are employed, variations in characteristics may occur due to factors such as substrate material properties.

*3: The configuration programs written to the EEPROM differ between “#HA2” and “#HA7”. For recommended part numbers, please refer to the No.2 PCB Design Checklist.

1.3 Supportive Information

#		Link
1	FAQ (frequently asked inquiries)	Web site
2	RZ Family Renesas Wiki	Web site
3	Technical support	Web site

2. Summary of Information by Category

This part shows the information about application notes by the category.

(Note: To access contents of sample code, My Renesas account is required.)

2.1 Overview

#	Category	Description
1	Standard	Hardware Design / Software for start-up / Clock / Voltage / Memory/Others

2.2 RZ/V2H Application Note [Standard]

#	Title	Contents	Sample code
1	RZ/V Getting Started with Flexible Software Package	This note describes how to create an application for the RZ/V using the Renesas Flexible Software Package (FSP).	-
2	RZ/V available partner camera module list	List of camera modules that can be connected to the RZ/V series.	-
3	RZ/V2H Group Lifetime Guideline	This note describes the guidelines for the lifetime of the RZ/V2H group.	-
4	RZ/V2H Group Thermal Design Guide Application Note	This note describes the guidelines for the thermal design of the RZ/V2H group.	-
5	RZ/V2H Group Reference power consumption guide(typ.) for use case	This note describes calculation results of power consumption for several use cases.	-
6	[NDA]DDR4TOP Application Note	This note describes the DRAM access configuration procedure for the LPDDR4/4X controller (DDR), and how to use Gen_tool.	-
7	[NDA]PCB Design Guidelines	This note describes the notices of PCB design for RZ/V2H group.	-
8	RZ/V2H Group CRU Application Note	This note describes setting examples for the CRU function of RZ/V2H Group.	-
9	Visual AI SLAM Solution Guide	This note describes the introduction of the Visual AI SLAM solution, which combines AI and SLAM.	Web site

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Apr. 25, 2025	-	The first edition issued
1.01	Jul. 4, 2025	1. The Table of Information and Materials Needed for Device Selection, Development and Mass Production	
		-	Updated links to the latest versions of each content
		2	No.6 New reference design (Power Sequencer & I/O Expander), added
		3	No.7 Reliability report, added
			No.10 Camera module list, added
			No.12 Link to CSM.SOL camera module information, added
			No.29 ISP support package guide, added
1.02	Oct. 3, 2025	1. The Table of Information and Materials Needed for Device Selection, Development and Mass Production	
		-	Updated links to the latest versions of each content
		2	No.6 Five reference designs, added
		3	No.13 Software Overview, How to Use Guide, Community, Reference Applications, added
			No.31 IQ Tuning Guide, added
			ROS2 support package, added
		4	No.37 TVM guideline, added
			No.43, No.44 AI Navigator, added
		5	No.2 PCB design checklist, added
			No.6 Note 2, added
			No.9 Recommended DRAM list, No.10 Recommended PMIC, No.13 BSDL, added
			1.3 Step3: Mass Production, deleted
		2. Summary of Information by Category	
		6	No.8 CRU Application Note, No.9 Visual AI SLAM Solution Guide, added

This handbook reflects information available as of Oct 2, 2025. For the latest information, please also refer to the product pages on our website ([RZ/V2H - Quad-core Vision AI MPU with DRP-AI3 Accelerator and High-Performance Real-time Processor | Renesas](#)).